

LM341/LM78MXX Series

3-Terminal Positive Voltage Regulators

General Description

The LM341 and LM78MXX series of three-terminal positive voltage regulators employ built-in current limiting, thermal shutdown, and safe-operating area protection which makes them virtually immune to damage from output overloads.

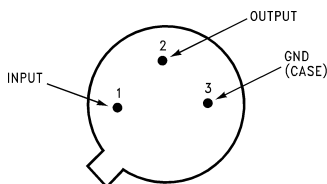
With adequate heatsinking, they can deliver in excess of 0.5A output current. Typical applications would include local (on-card) regulators which can eliminate the noise and degraded performance associated with single-point regulation.

Features

- Output current in excess of 0.5A
- No external components
- Internal thermal overload protection
- Internal short circuit current-limiting
- Output transistor safe-area compensation
- Available in TO-220, TO-39, and TO-252 D-PAK packages
- Output voltages of 5V, 12V, and 15V

Connection Diagrams

TO-39 Metal Can Package (H)

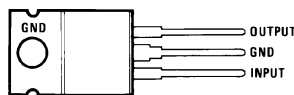


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Bottom View

Order Number LM78M05CH, LM78M12CH or LM78M15CH
See NS Package Number H03A

TO-220 Power Package (T)

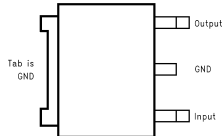


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Top View

Order Number LM341T-5.0, LM341T-12, LM341T-15, LM78M05CT, LM78M12CT or LM78M15CT
See NS Package Number T03B

TO-252



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Top View

Order Number LM78M05CDT
See NS Package Number TD03B

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Lead Temperature (Soldering, 10 seconds)	
TO-39 Package (H)	300°C
TO-220 Package (T)	260°C
Storage Temperature Range	-65°C to +150°C

Operating Junction Temperature

Range -40°C to +125°C

Power Dissipation (Note 2)

Internally Limited

Input Voltage

 $5V \leq V_O \leq 15V$ 35V

ESD Susceptibility

TBD

Electrical Characteristics

Limits in standard typeface are for $T_J = 25^\circ\text{C}$, and limits in **boldface type** apply over the -40°C to $+125^\circ\text{C}$ operating temperature range. Limits are guaranteed by production testing or correlation techniques using standard Statistical Quality Control (SQC) methods.

LM341-5.0, LM78M05C

Unless otherwise specified: $V_{IN} = 10V$, $C_{IN} = 0.33 \mu\text{F}$, $C_O = 0.1 \mu\text{F}$

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_O	Output Voltage	$I_L = 500 \text{ mA}$	4.8	5.0	5.2	V
		$5 \text{ mA} \leq I_L \leq 500 \text{ mA}$	4.75	5.0	5.25	
		$P_D \leq 7.5W$, $7.5V \leq V_{IN} \leq 20V$				
$V_{R \text{ LINE}}$	Line Regulation	$7.2V \leq V_{IN} \leq 25V$			50	mV
		$I_L = 100 \text{ mA}$			100	
$V_{R \text{ LOAD}}$	Load Regulation	$5 \text{ mA} \leq I_L \leq 500 \text{ mA}$			100	
I_Q	Quiescent Current	$I_L = 500 \text{ mA}$		4	10.0	mA
ΔI_Q	Quiescent Current Change	$5 \text{ mA} \leq I_L \leq 500 \text{ mA}$			0.5	
		$7.5V \leq V_{IN} \leq 25V$, $I_L = 500 \text{ mA}$			1.0	
V_n	Output Noise Voltage	$f = 10 \text{ Hz to } 100 \text{ kHz}$		40		μV
$\frac{\Delta V_{IN}}{\Delta V_O}$	Ripple Rejection	$f = 120 \text{ Hz}$, $I_L = 500 \text{ mA}$		78		dB
V_{IN}	Input Voltage Required to Maintain Line Regulation	$I_L = 500 \text{ mA}$	7.2			V
ΔV_O	Long Term Stability	$I_L = 500 \text{ mA}$			20	mV/khrs

Electrical Characteristics

Limits in standard typeface are for $T_J = 25^\circ\text{C}$, and limits in **boldface type** apply over the -40°C to $+125^\circ\text{C}$ operating temperature range. Limits are guaranteed by production testing or correlation techniques using standard Statistical Quality Control (SQC) methods. (Continued)

LM341-12, LM78M12C

Unless otherwise specified: $V_{IN} = 19\text{V}$, $C_{IN} = 0.33\ \mu\text{F}$, $C_O = 0.1\ \mu\text{F}$

Symbol	Parameter	Conditions		Min	Typ	Max	Units
V _O	Output Voltage	I _L = 500 mA		11.5	12	12.5	V
		5 mA ≤ I _L ≤ 500 mA		11.4	12	12.6	
		P _D ≤ 7.5W, 14.8V ≤ V _{IN} ≤ 27V					
V _{R LINE}	Line Regulation	14.5V ≤ V _{IN} ≤ 30V	I _L = 100 mA			120	mV
			I _L = 500 mA			240	
						240	
V _{R LOAD}	Load Regulation	5 mA ≤ I _L ≤ 500 mA				240	
I _Q	Quiescent Current	I _L = 500 mA			4	10.0	mA
ΔI _Q	Quiescent Current Change	5 mA ≤ I _L ≤ 500 mA				0.5	
		14.8V ≤ V _{IN} ≤ 30V, I _L = 500 mA				1.0	
V _n	Output Noise Voltage	f = 10 Hz to 100 kHz			75		μV
$\frac{\Delta V_{IN}}{\Delta V_O}$	Ripple Rejection	f = 120 Hz, I _L = 500 mA			71		dB
V _{IN}	Input Voltage Required to Maintain Line Regulation	I _L = 500 mA		14.5			V
ΔV _O	Long Term Stability	I _L = 500 mA				48	mV/khrs

LM341-15, LM78M15C

Unless otherwise specified: $V_{IN} = 23\text{V}$, $C_{IN} = 0.33\ \mu\text{F}$, $C_O = 0.1\ \mu\text{F}$

Symbol	Parameter	Conditions		Min	Typ	Max	Units
V _O	Output Voltage	I _L = 500 mA		14.4	15	15.6	V
		5 mA ≤ I _L ≤ 500 mA		14.25	15	15.75	
		P _D ≤ 7.5W, 18V ≤ V _{IN} ≤ 30V					
V _{R LINE}	Line Regulation	17.6V ≤ V _{IN} ≤ 30V	I _L = 100 mA			150	mV
			I _L = 500 mA			300	
		5 mA ≤ I _L ≤ 500 mA				300	
V _{R LOAD}	Load Regulation	5 mA ≤ I _L ≤ 500 mA				300	
I _Q	Quiescent Current	I _L = 500 mA			4	10.0	mA
ΔI _Q	Quiescent Current Change	5 mA ≤ I _L ≤ 500 mA				0.5	
		18V ≤ V _{IN} ≤ 30V, I _L = 500 mA				1.0	
V _n	Output Noise Voltage	f = 10 Hz to 100 kHz			90		μV
$\frac{\Delta V_{IN}}{\Delta V_O}$	Ripple Rejection	f = 120 Hz, I _L = 500 mA			69		dB
V _{IN}	Input Voltage Required to Maintain Line Regulation	I _L = 500 mA		17.6			V
ΔV _O	Long Term Stability	I _L = 500 mA				60	mV/khrs

Note 1: Absolute maximum ratings indicate limits beyond which damage to the component may occur. Electrical specifications do not apply when operating the device outside of its rated operating conditions.

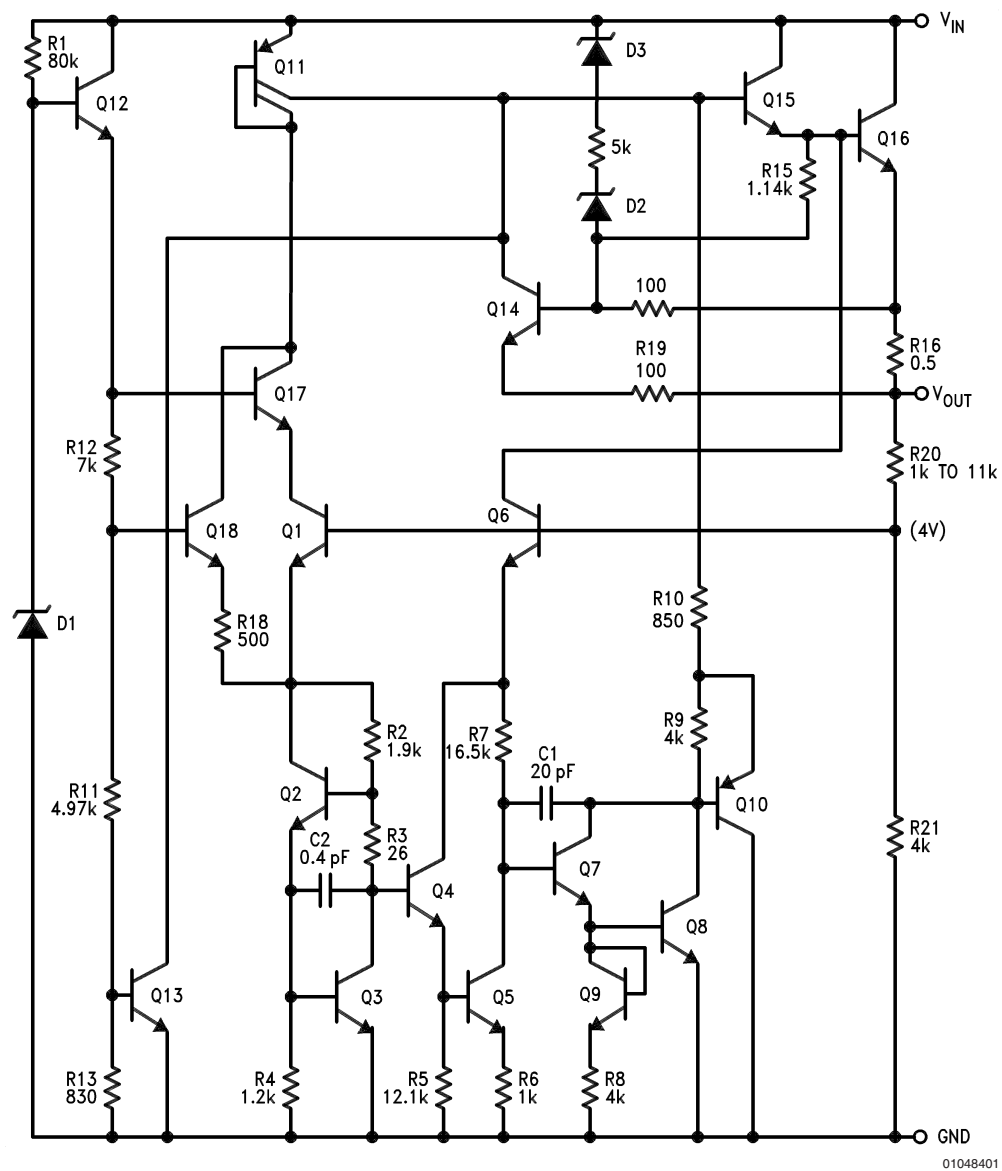
Note 2: The typical thermal resistance of the three package types is:

T (TO-220) package: $\theta_{JA} = 60^\circ\text{C/W}$, $\theta_{JC} = 5^\circ\text{C/W}$

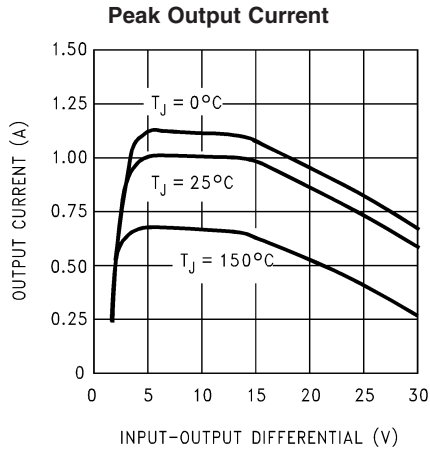
H (TO-39) package: $\theta_{JA} = 120^\circ\text{C/W}$, $\theta_{JC} = 18^\circ\text{C/W}$

DT (TO-252) package: $\theta_{JA} = 92^\circ\text{C/W}$, $\theta_{JC} = 10^\circ\text{C/W}$

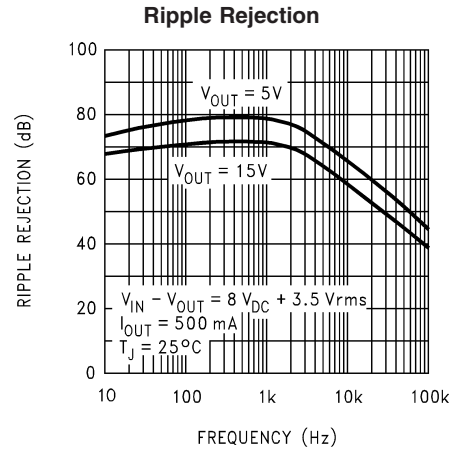
Schematic Diagram



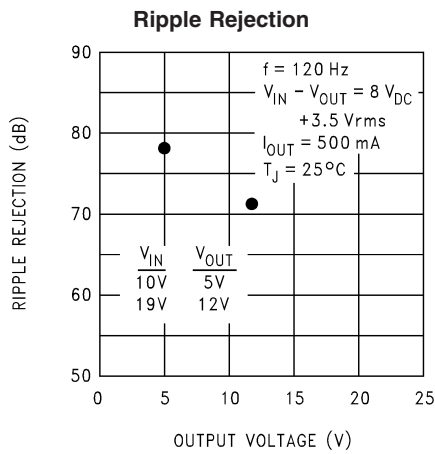
Typical Performance Characteristics



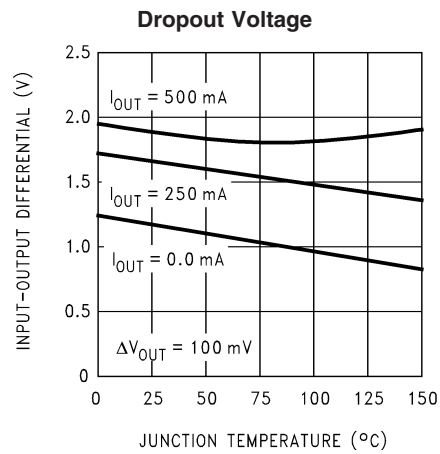
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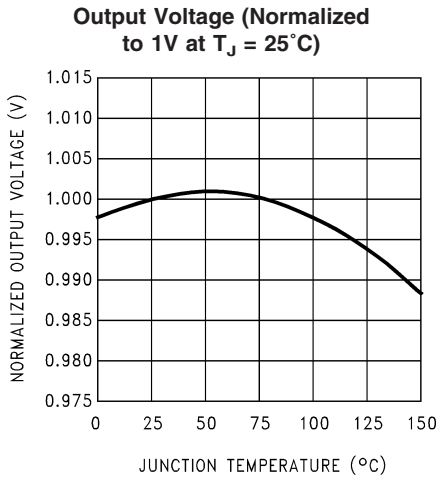
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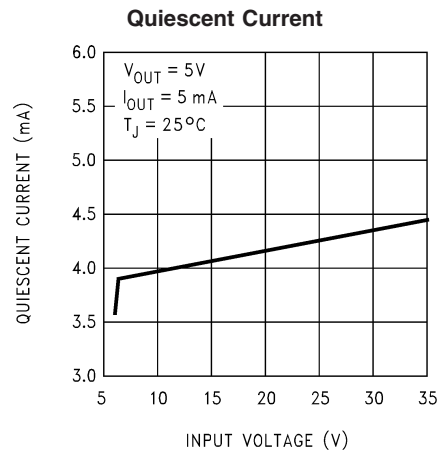
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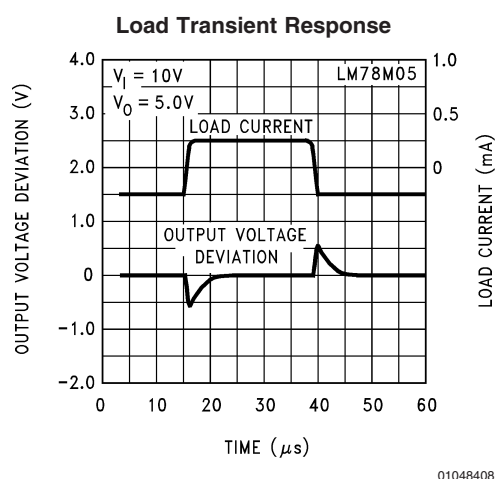
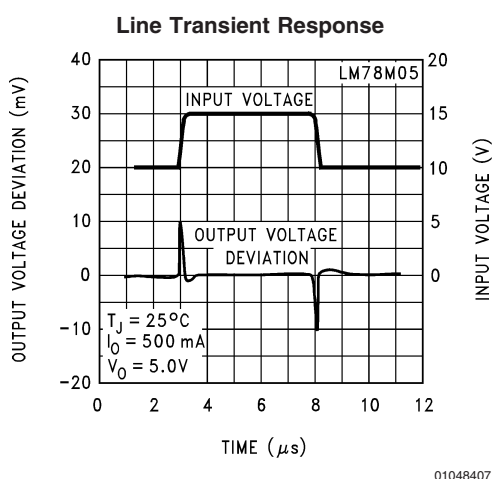
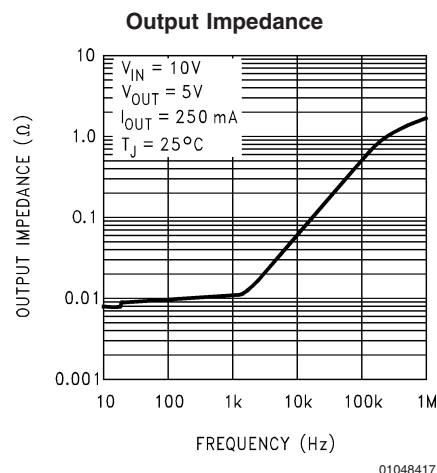
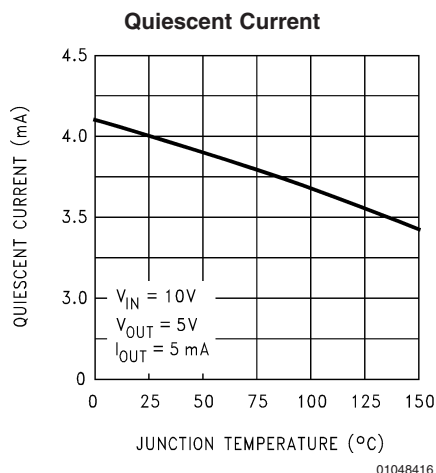


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Typical Performance Characteristics (Continued)



Design Considerations

The LM78MXX/LM341XX fixed voltage regulator series has built-in thermal overload protection which prevents the device from being damaged due to excessive junction temperature.

The regulators also contain internal short-circuit protection which limits the maximum output current, and safe-area protection for the pass transistor which reduces the short-circuit current as the voltage across the pass transistor is increased.

Although the internal power dissipation is automatically limited, the maximum junction temperature of the device must be kept below +125°C in order to meet data sheet specifications. An adequate heatsink should be provided to assure this limit is not exceeded under worst-case operating conditions (maximum input voltage and load current) if reliable performance is to be obtained).

1.0 HEATSINK CONSIDERATIONS

When an integrated circuit operates with appreciable current, its junction temperature is elevated. It is important to quantify its thermal limits in order to achieve acceptable performance and reliability. This limit is determined by summing the individual parts consisting of a series of temperature rises from the semiconductor junction to the operating environment. A one-dimension steady-state model of con-

duction heat transfer is demonstrated in The heat generated at the device junction flows through the die to the die attach pad, through the lead frame to the surrounding case material, to the printed circuit board, and eventually to the ambient environment. Below is a list of variables that may affect the thermal resistance and in turn the need for a heatsink.

R^{θ}_{JC} (Component Variables)

Leadframe Size & Material
No. of Conduction Pins
Die Size
Die Attach Material
Molding Compound Size and Material

R^{θ}_{CA} (Application Variables)

Mounting Pad Size, Material, & Location
Placement of Mounting Pad
PCB Size & Material
Traces Length & Width
Adjacent Heat Sources
Volume of Air
Air Flow
Ambient Temperature
Shape of Mounting Pad

Application Information

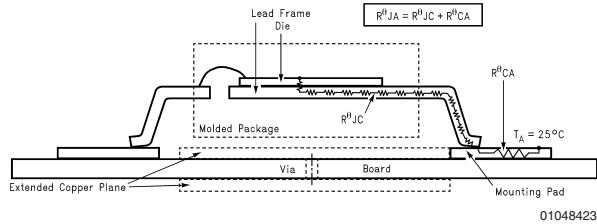


FIGURE 1. Cross-sectional view of Integrated Circuit Mounted on a printed circuit board. Note that the case temperature is measured at the point where the leads contact with the mounting pad surface

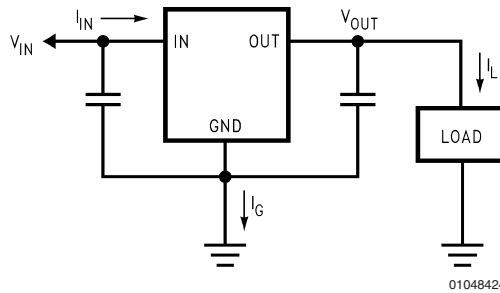


FIGURE 2. Power Dissipation Diagram

The next parameter which must be calculated is the maximum allowable temperature rise, $T_R(\text{max})$:

$$\theta_{JA} = T_R(\text{max})/P_D$$

If the maximum allowable value for θ_{JA} °C/W is found to be $\geq 60^\circ\text{C/W}$ for TO-220 package or $\geq 92^\circ\text{C/W}$ for TO-252 package, no heatsink is needed since the package alone will dissipate enough heat to satisfy these requirements. If the calculated value for θ_{JA} fall below these limits, a heatsink is required.

As a design aid, *Table 1* shows the value of the θ_{JA} of TO-252 for different heatsink area. The copper patterns that

The LM78MXX/LM341XX regulators have internal thermal shutdown to protect the device from over-heating. Under all possible operating conditions, the junction temperature of the LM78MXX/LM341XX must be within the range of 0°C to 125°C . A heatsink may be required depending on the maximum power dissipation and maximum ambient temperature of the application. To determine if a heatsink is needed, the power dissipated by the regulator, P_D , must be calculated:

$$I_{IN} = I_L + I_G$$

$$P_D = (V_{IN} - V_{OUT}) I_L + V_{IN} I_G$$

shows the voltages and currents which are present in the circuit.

we used to measure these θ_{JA} are shown at the end of the Application Note Section. reflects the same test results as what are in the *Table 1*

shows the maximum allowable power dissipation vs. ambient temperature for the TO-252 device. shows the maximum allowable power dissipation vs. copper area (in^2) for the TO-252 device. Please see AN1028 for power enhancement techniques to be used with TO-252 package.

Application Information (Continued)**TABLE 1. θ_{JA} Different Heatsink Area**

Layout	Copper Area		Thermal Resistance (θ_{JA} , °C/W) TO-252
	Top Side (in ²)*	Bottom Side (in ²)	
1	0.0123	0	103
2	0.066	0	87
3	0.3	0	60
4	0.53	0	54
5	0.76	0	52
6	1	0	47
7	0	0.2	84
8	0	0.4	70
9	0	0.6	63
10	0	0.8	57
11	0	1	57
12	0.066	0.066	89
13	0.175	0.175	72
14	0.284	0.284	61
15	0.392	0.392	55
16	0.5	0.5	53

*Tab of device attached to topside copper

Application Information (Continued)

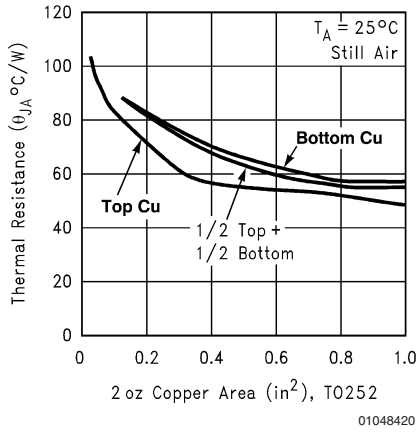


FIGURE 3. θ_{JA} vs. 2oz Copper Area for TO-252

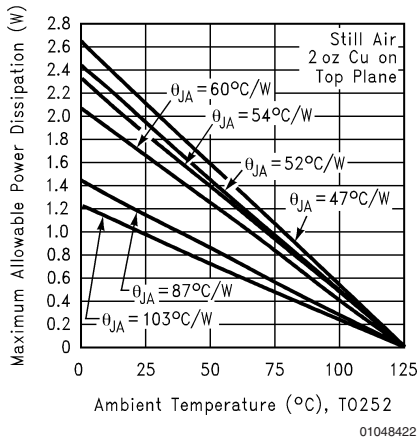


FIGURE 4. Maximum Allowable Power Dissipation vs. Ambient Temperature for TO-252

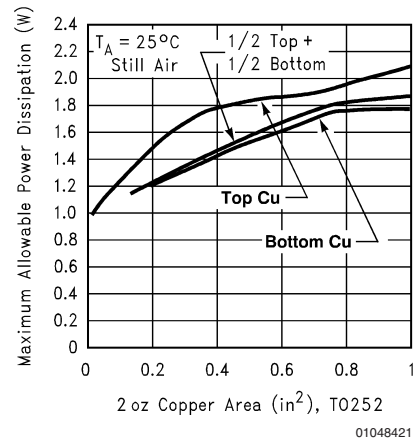
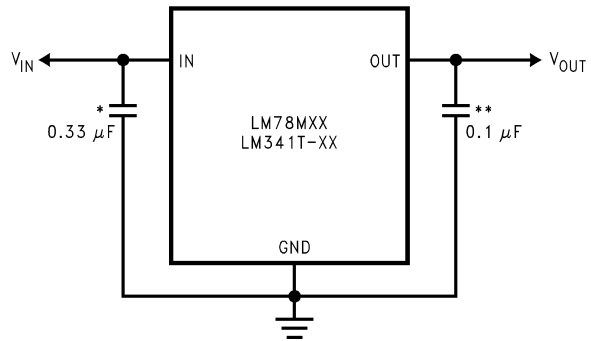


FIGURE 5. Maximum Allowable Power Dissipation vs. 2oz. Copper Area for TO-252

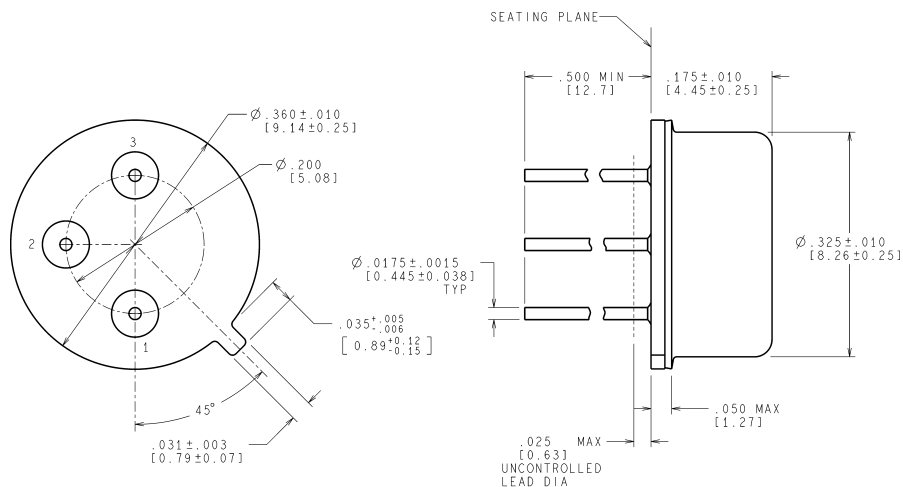
Typical Application



*Required if regulator input is more than 4 inches from input filter capacitor (or if no input filter capacitor is used).

**Optional for improved transient response.

Physical Dimensions inches (millimeters) unless otherwise noted

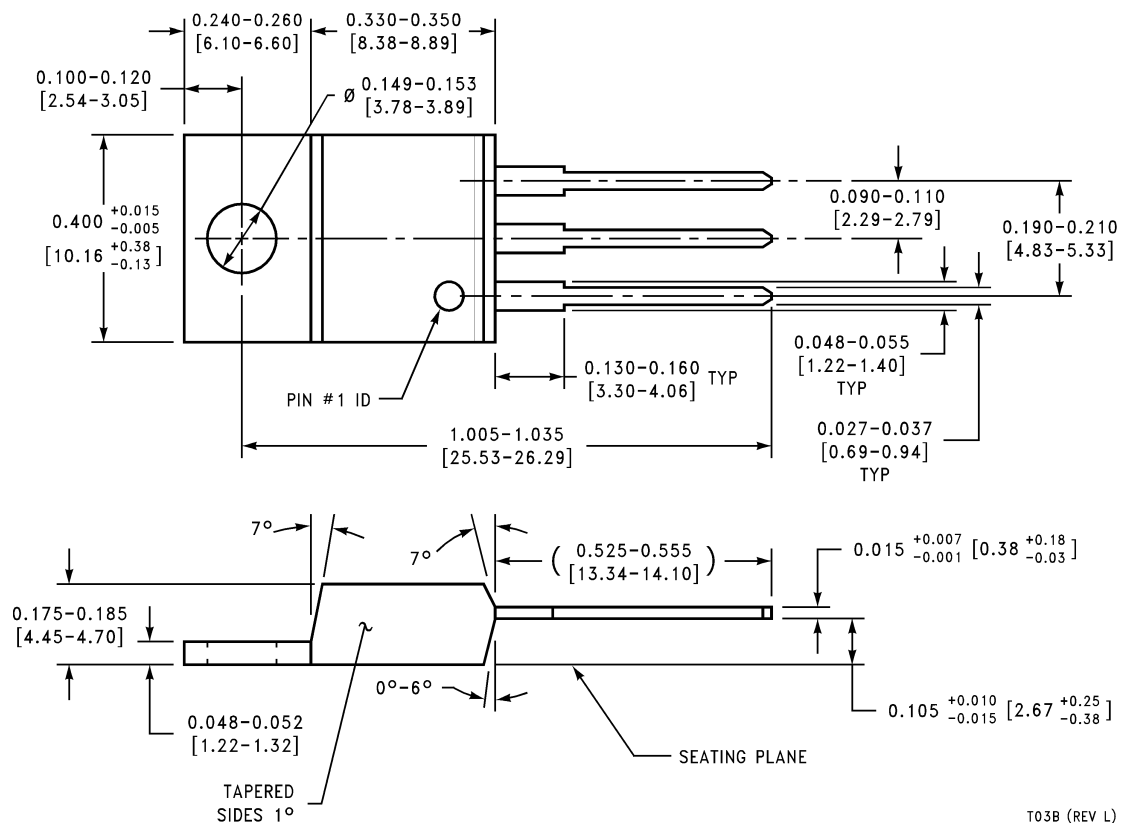


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CONFIGURATION CONTROL

H03A (Rev D)

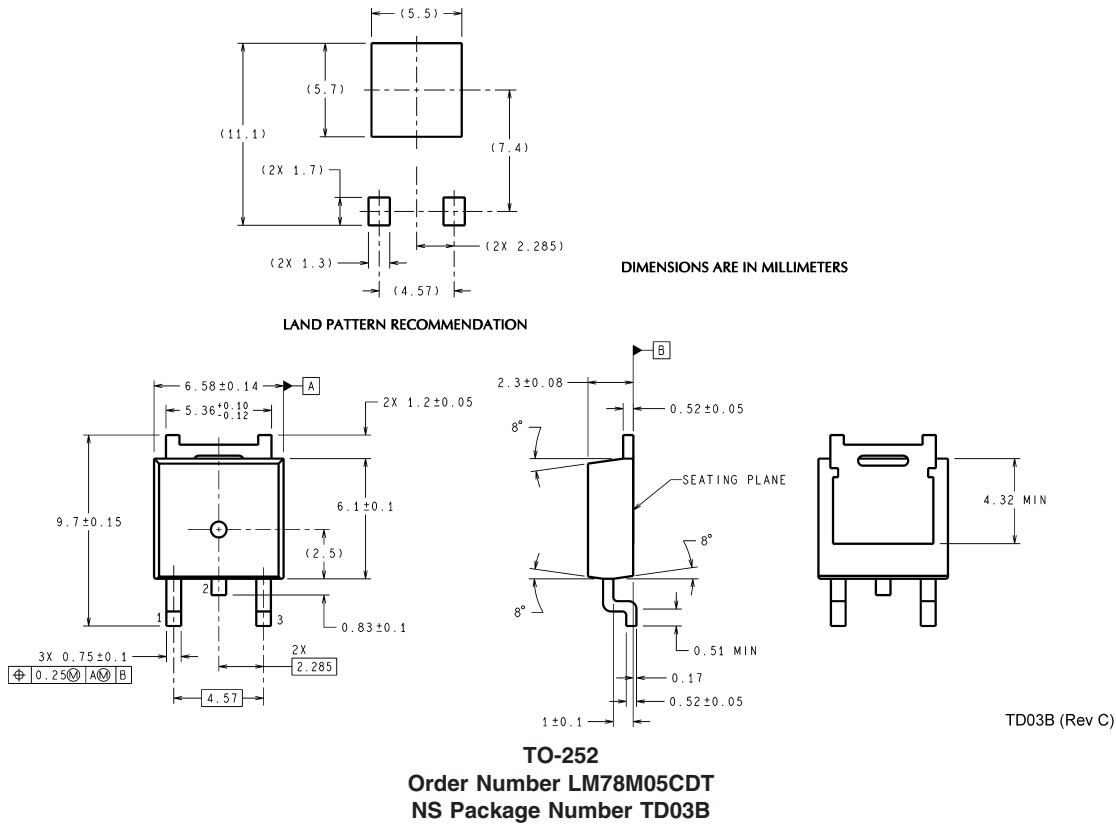
TO-39 Metal Can Package (H) Order Number LM78M05CH, LM78M12CH or LM78M15CH NS Package Number H03A



T03B (REV L)

TO-220 Power Package (T) Order Number LM341T-5.0, LM341T-12, LM341T-15, LM78M05CT, LM78M12CT or LM78M15CT NS Package Number T03B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



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